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Details	
Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	32MHz
Connectivity	I ² C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	12
Program Memory Size	8KB (2.75K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 7x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	14-TSSOP (0.173", 4.40mm Width)
Supplier Device Package	14-TSSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24f08kl200-i-st

PIC24F16KL402 FAMILY

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4.1.1 PROGRAM MEMORY ORGANIZATION

The program memory space is organized in word-addressable blocks. Although it is treated as 24 bits wide, it is more appropriate to think of each address of the program memory as a lower and upper word, with the upper byte of the upper word being unimplemented. The lower word always has an even address, while the upper word has an odd address, as shown in Figure 4-2.

Program memory addresses are always word-aligned on the lower word, and addresses are incremented or decremented by two during code execution. This arrangement also provides compatibility with data memory space addressing and makes it possible to access data in the program memory space.

4.1.2 HARD MEMORY VECTORS

All PIC24F devices reserve the addresses between 00000h and 000200h for hard-coded program execution vectors. A hardware Reset vector is provided to redirect code execution from the default value of the PC on device Reset to the actual start of code. A GOTO instruction is programmed by the user at 000000h, with the actual address for the start of code at 000002h.

PIC24F devices also have two Interrupt Vector Tables (IVT), located from 000004h to 0000FFh and 000104h to 0001FFh. These vector tables allow each of the many device interrupt sources to be handled by separate ISRs. A more detailed discussion of the Interrupt Vector Tables is provided in **Section 8.1 “Interrupt Vector Table (IVT)”**.

4.1.3 DATA EEPROM

In the PIC24F16KL402 family, the data EEPROM is mapped to the top of the user program memory space, starting at address, 7FFE00, and expanding up to address, 7FFFFF.

The data EEPROM is organized as 16-bit wide memory and 256 words deep. This memory is accessed using Table Read and Table Write operations, similar to the user code memory.

4.1.4 DEVICE CONFIGURATION WORDS

Table 4-1 provides the addresses of the device Configuration Words for the PIC24F16KL402 family. Their location in the memory map is shown in Figure 4-1.

For more information on device Configuration Words, see **Section 23.0 “Special Features”**.

TABLE 4-1: DEVICE CONFIGURATION WORDS FOR PIC24F16KL402 FAMILY DEVICES

Configuration Words	Configuration Word Addresses
FBS	F80000
FGS	F80004
FOSCSEL	F80006
FOSC	F80008
FWDT	F8000A
FPOR	F8000C
FICD	F8000E

FIGURE 4-2: PROGRAM MEMORY ORGANIZATION

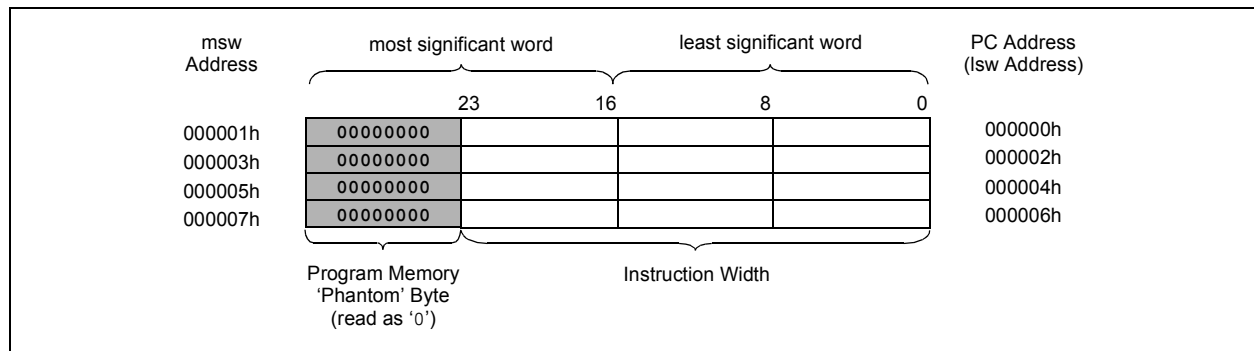


TABLE 4-4: ICN REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
CNPD1	0056	CN15PDE ⁽¹⁾	CN14PDE ⁽¹⁾	CN13PDE ⁽¹⁾	CN12PDE	CN11PDE	—	CN9PDE ⁽²⁾	CN8PDE	CN7PDE ⁽²⁾	CN6PDE ⁽¹⁾	CN5PDE ⁽¹⁾	CN4PDE ⁽¹⁾	CN3PDE	CN2PDE	CN1PDE	CN0PDE	0000
CNPD2	0058	—	CN30PDE	CN29PDE	—	CN27PDE ⁽²⁾	—	—	CN24PDE ⁽²⁾	CN23PDE ⁽¹⁾	CN22PDE	CN21PDE	—	—	—	—	CN16PDE ⁽²⁾	0000
CNEN1	0062	CN15IE ⁽¹⁾	CN14IE ⁽¹⁾	CN13IE ⁽¹⁾	CN12IE	CN11IE	—	CN9IE ⁽¹⁾	CN8IE	CN7IE ⁽¹⁾	CN6IE ⁽²⁾	CN5PIE ⁽²⁾	CN4IE ⁽²⁾	CN3IE	CNIE	CN1IE	CN0IE	0000
CNEN2	0064	—	CN30IE	CN29IE	—	CN27IE ⁽²⁾	—	—	CN24IE ⁽²⁾	CN23IE ⁽¹⁾	CN22IE	CN21IE	—	—	—	—	CN16IE ⁽²⁾	0000
CNPU1	006E	CN15PUE ⁽¹⁾	CN14PUE ⁽¹⁾	CN13PUE ⁽¹⁾	CN12PUE	CN11PUE	—	CN9PUE ⁽¹⁾	CN8PUE	CN7PUE ⁽¹⁾	CN6PUE ⁽²⁾	CN5PUE ⁽²⁾	CN4PUE ⁽²⁾	CN3PUE	CN2PUE	CN1PUE	CN0PUE	0000
CNPU2	0070	—	CN30PUE	CN29PUE	—	CN27PUE ⁽²⁾	—	—	CN24PUE ⁽²⁾	CN23PUE ⁽¹⁾	CN22PUE	CN21PUE	—	—	—	—	CN16PUE ⁽²⁾	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: These bits are unimplemented in 14-pin devices; read as '0'.

Note 2: These bits are unimplemented in 14-pin and 20-pin devices; read as '0'.

TABLE 4-16: SYSTEM REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
RCON	0740	TRAPR	IOPUWR	SBOREN	—	—	—	CM	PMSLP	EXTR	SWR	SWDTEN	WDTO	SLEEP	IDLE	BOR	POR	(Note 1)
OSCCON	0742	—	COSC2	COSC1	COSC0	—	NOSC2	NOSC1	NOSC0	CLKLOCK	—	LOCK	—	CF	SOSCDRV	SOSCEN	OSWEN	(Note 2)
CLKDIV	0744	ROI	DOZE2	DOZE1	DOZE0	DOZEN	RCDIV2	RCDIV1	RCDIV0	—	—	—	—	—	—	—	—	3100
OSCTUN	0748	—	—	—	—	—	—	—	—	—	—	TUN5	TUN4	TUN3	TUN2	TUN1	TUN0	0000
REFOCON	074E	ROEN	—	ROSSLP	ROSEL	RODIV3	RODIV2	RODIV1	RODIV0	—	—	—	—	—	—	—	—	0000
HLVDCON	0756	HLVDEN	—	HLSIDL	—	—	—	—	—	VDIR	BGVST	IRVST	—	HLVDL3	HLVDL2	HLVDL1	HLVDL0	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: RCON register Reset values are dependent on the type of Reset.

2: OSCCON register Reset values are dependent on configuration fuses and by type of Reset.

TABLE 4-17: NVM REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
NVMCON	0760	WR	WREN	WRERR	PGMONLY	—	—	—	—	—	ERASE	NVMOP5	NVMOP4	NVMOP3	NVMOP2	NVMOP1	NVMOP0	0000
NVMKEY	0766	—	—	—	—	—	—	—	—	NVM Key Register								0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-18: ULTRA LOW-POWER WAKE-UP REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
ULPWCON	0768	ULPEN	—	ULPSIDL	—	—	—	—	ULPSINK	—	—	—	—	—	—	—	—	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-19: PMD REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
PMD1	0770	—	T4MD	T3MD	T2MD	T1MD	—	—	—	SSP1MD	U2MD	U1MD	—	—	—	—	ADC1MD	0000
PMD2	0772	—	—	—	—	—	—	—	—	—	—	—	—	—	CCP3MD	CCP2MD	CCP1MD	0000
PMD3	0774	—	—	—	—	—	CMPMD	—	—	—	—	—	—	—	—	SSP2MD	—	0000
PMD4	0776	—	—	—	—	—	—	—	—	ULPWUMD	—	—	EEMD	REFOMD	—	HLVDMD	—	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

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REGISTER 7-1: RCON: RESET CONTROL REGISTER⁽¹⁾

R/W-0	R/W-0	R/W-0 ⁽³⁾	U-0	U-0	U-0	R/W-0	R/W-0
TRAPR	IOPUWR	SBOREN	—	—	—	CM	PMSLP
bit 15						bit 8	

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-1	R/W-1
EXTR	SWR	SWDTEN ⁽²⁾	WDTO	SLEEP	IDLE	BOR	POR
bit 7						bit 0	

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

- bit 15 **TRAPR:** Trap Reset Flag bit
 1 = A Trap Conflict Reset has occurred
 0 = A Trap Conflict Reset has not occurred
- bit 14 **IOPUWR:** Illegal Opcode or Uninitialized W Access Reset Flag bit
 1 = An illegal opcode detection, an illegal address mode or an Uninitialized W register is used as an Address Pointer and caused a Reset
 0 = An illegal opcode or Uninitialized W register Reset has not occurred
- bit 13 **SBOREN:** Software Enable/Disable of BOR bit⁽³⁾
 1 = BOR is turned on in software
 0 = BOR is turned off in software
- bit 12-10 **Unimplemented:** Read as '0'
- bit 9 **CM:** Configuration Word Mismatch Reset Flag bit
 1 = A Configuration Word Mismatch Reset has occurred
 0 = A Configuration Word Mismatch Reset has not occurred
- bit 8 **PMSLP:** Program Memory Power During Sleep bit
 1 = Program memory bias voltage remains powered during Sleep
 0 = Program memory bias voltage is powered down during Sleep
- bit 7 **EXTR:** External Reset ($\overline{\text{MCLR}}$) Pin bit
 1 = A Master Clear (pin) Reset has occurred
 0 = A Master Clear (pin) Reset has not occurred
- bit 6 **SWR:** Software Reset (Instruction) Flag bit
 1 = A `RESET` instruction has been executed
 0 = A `RESET` instruction has not been executed
- bit 5 **SWDTEN:** Software Enable/Disable of WDT bit⁽²⁾
 1 = WDT is enabled
 0 = WDT is disabled
- bit 4 **WDTO:** Watchdog Timer Time-out Flag bit
 1 = WDT time-out has occurred
 0 = WDT time-out has not occurred

Note 1: All of the Reset status bits may be set or cleared in software. Setting one of these bits in software does not cause a device Reset.

2: If the `FWDTEN` Configuration bit is '1' (unprogrammed), the WDT is always enabled, regardless of the `SWDTEN` bit setting.

3: The `SBOREN` bit is forced to '0' when disabled by the Configuration bits, `BOREN<1:0>` (`FPOR<1:0>`). When the Configuration bits are set to enable `SBOREN`, the default Reset state will be '1'.

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REGISTER 8-1: SR: ALU STATUS REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
—	—	—	—	—	—	—	DC ⁽¹⁾
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0
IPL ₂ ^(2,3)	IPL ₁ ^(2,3)	IPL ₀ ^(2,3)	RA ⁽¹⁾	N ⁽¹⁾	OV ⁽¹⁾	Z ⁽¹⁾	C ⁽¹⁾
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
 -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-9 **Unimplemented:** Read as '0'

bit 7-5 **IPL<2:0>:** CPU Interrupt Priority Level Status bits^(2,3)

- 111 = CPU Interrupt Priority Level is 7 (15); user interrupts disabled
- 110 = CPU Interrupt Priority Level is 6 (14)
- 101 = CPU Interrupt Priority Level is 5 (13)
- 100 = CPU Interrupt Priority Level is 4 (12)
- 011 = CPU Interrupt Priority Level is 3 (11)
- 010 = CPU Interrupt Priority Level is 2 (10)
- 001 = CPU Interrupt Priority Level is 1 (9)
- 000 = CPU Interrupt Priority Level is 0 (8)

- Note 1:** See Register 3-1 for the description of these bits, which are not dedicated to interrupt control functions.
- 2:** The IPL bits are concatenated with the IPL3 bit (CORCON<3>) to form the CPU Interrupt Priority Level. The value in parentheses indicates the Interrupt Priority Level if IPL3 = 1.
- 3:** The IPL Status bits are read-only when NSTDIS (INTCON1<15>) = 1.

Note: Bit 8 and bits 4 through 0 are described in **Section 3.0 "CPU"**.

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REGISTER 8-4: INTCON2: INTERRUPT CONTROL REGISTER2

R/W-0	R-0, HSC	U-0	U-0	U-0	U-0	U-0	U-0
ALTIVT	DISI	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
—	—	—	—	—	INT2EP	INT1EP	INT0EP
bit 7						bit 0	

Legend:	HSC = Hardware Settable/Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

- bit 15 **ALTIVT:** Enable Alternate Interrupt Vector Table bit
1 = Uses Alternate Interrupt Vector Table
0 = Uses standard (default) vector table
- bit 14 **DISI:** DISI Instruction Status bit
1 = DISI instruction is active
0 = DISI instruction is not active
- bit 13-3 **Unimplemented:** Read as '0'
- bit 2 **INT2EP:** External Interrupt 2 Edge Detect Polarity Select bit
1 = Interrupt on negative edge
0 = Interrupt on positive edge
- bit 1 **INT1EP:** External Interrupt 1 Edge Detect Polarity Select bit
1 = Interrupt on negative edge
0 = Interrupt on positive edge
- bit 0 **INT0EP:** External Interrupt 0 Edge Detect Polarity Select bit
1 = Interrupt on negative edge
0 = Interrupt on positive edge

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REGISTER 8-7: IFS2: INTERRUPT FLAG STATUS REGISTER 2

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
—	—	T3GIF	—	—	—	—	—
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
 -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

- bit 15-6 **Unimplemented:** Read as '0'
- bit 5 **T3GIF:** Timer3 External Gate Interrupt Flag Status bit
 1 = Interrupt request has occurred
 0 = Interrupt request has not occurred
- bit 4-0 **Unimplemented:** Read as '0'

REGISTER 8-8: IFS3: INTERRUPT FLAG STATUS REGISTER 3

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	U-0
—	—	—	—	—	BCL2IF ⁽¹⁾	SSP2IF ⁽¹⁾	—
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
 -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

- bit 15-3 **Unimplemented:** Read as '0'
- bit 2 **BCL2IF:** MSSP2 I²C™ Bus Collision Interrupt Flag Status bit⁽¹⁾
 1 = Interrupt request has occurred
 0 = Interrupt request has not occurred
- bit 1 **SSP2IF:** MSSP2 SPI/I²C Event Interrupt Flag Status bit⁽¹⁾
 1 = Interrupt request has occurred
 0 = Interrupt request has not occurred
- bit 0 **Unimplemented:** Read as '0'

Note 1: These bits are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X devices.

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REGISTER 8-25: IPC9: INTERRUPT PRIORITY CONTROL REGISTER 9

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15						bit 8	

U-0	R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0
—	T3GIP2	T3GIP1	T3GIP0	—	—	—	—
bit 7						bit 0	

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-7 **Unimplemented:** Read as '0'

bit 6-4 **T3GIP<2:0>:** Timer3 External Gate Interrupt Priority bits

111 = Interrupt is Priority 7 (highest priority interrupt)

•

•

001 = Interrupt is Priority 1

000 = Interrupt source is disabled

bit 3-0 **Unimplemented:** Read as '0'

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9.1 CPU Clocking Scheme

The system clock source can be provided by one of four sources:

- Primary Oscillator (POSC) on the OSC1 and OSC0 pins
- Secondary Oscillator (SOSC) on the SOSCI and SOSCO pins
PIC24F16KL402 family devices consist of two types of secondary oscillators:
 - High-Power Secondary Oscillator
 - Low-Power Secondary Oscillator
 These can be selected by using the SOSCSEL (FOSC<5>) bit.
- Fast Internal RC (FRC) Oscillator
 - 8 MHz FRC Oscillator
 - 500 kHz Lower Power FRC Oscillator
- Low-Power Internal RC (LPRC) Oscillator with two modes:
 - High-Power/High-Accuracy mode
 - Low-Power/Low-Accuracy mode

The primary oscillator and 8 MHz FRC sources have the option of using the internal 4x PLL. The frequency of the FRC clock source can optionally be reduced by the programmable clock divider. The selected clock source generates the processor and peripheral clock sources.

The processor clock source is divided by two to produce the internal instruction cycle clock, Fcy. In this document, the instruction cycle clock is also denoted by Fosc/2. The internal instruction cycle clock, Fosc/2, can be provided on the OSC0 I/O pin for some operating modes of the primary oscillator.

9.2 Initial Configuration on POR

The oscillator source (and operating mode) that is used at a device Power-on Reset (POR) event is selected using Configuration bit settings. The Oscillator Configuration bit settings are located in the Configuration registers in the program memory (for more information, see **Section 23.2 “Configuration Bits”**). The Primary Oscillator Configuration bits, POSCMD<1:0> (FOSC<1:0>), and the Initial Oscillator Select Configuration bits, FNOSC<2:0> (FOSCSEL<2:0>), select the oscillator source that is used at a POR. The FRC Primary Oscillator with Postscaler (FRCDIV) is the default (unprogrammed) selection. The secondary oscillator, or one of the internal oscillators, may be chosen by programming these bit locations. The EC mode Frequency Range Configuration bits, POSCFREQ<1:0> (FOSC<4:3>), optimize power consumption when running in EC mode. The default configuration is “frequency range is greater than 8 MHz”.

The Configuration bits allow users to choose between the various clock modes, shown in Table 9-1.

9.2.1 CLOCK SWITCHING MODE CONFIGURATION BITS

The FCKSMx Configuration bits (FOSC<7:6>) are used jointly to configure device clock switching and the FSCM. Clock switching is enabled only when FCKSM1 is programmed ('0'). The FSCM is enabled only when FCKSM<1:0> are both programmed ('00').

TABLE 9-1: CONFIGURATION BIT VALUES FOR CLOCK SELECTION

Oscillator Mode	Oscillator Source	POSCMD<1:0>	FNOSC<2:0>	Notes
8 MHz FRC Oscillator with Postscaler (FRCDIV)	Internal	11	111	1, 2
500 kHz FRC Oscillator with Postscaler (LPFRCDIV)	Internal	11	110	1
Low-Power RC Oscillator (LPRC)	Internal	11	101	1
Secondary (Timer1) Oscillator (SOSC)	Secondary	00	100	1
Primary Oscillator (HS) with PLL Module (HSPLL)	Primary	10	011	
Primary Oscillator (EC) with PLL Module (ECPLL)	Primary	00	011	
Primary Oscillator (HS)	Primary	10	010	
Primary Oscillator (XT)	Primary	01	010	
Primary Oscillator (EC)	Primary	00	010	
8 MHz FRC Oscillator with PLL Module (FRCPLL)	Internal	11	001	1
8 MHz FRC Oscillator (FRC)	Internal	11	000	1

Note 1: OSC0 pin function is determined by the OSCIOFNC Configuration bit.

2: This is the default oscillator mode for an unprogrammed (erased) device.

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11.3 Input Change Notification

The Input Change Notification (ICN) function of the I/O ports allows the PIC24F16KL402 family of devices to generate interrupt requests to the processor in response to a Change-of-State (COS) on selected input pins. This feature is capable of detecting input Change-of-States, even in Sleep mode, when the clocks are disabled. Depending on the device pin count, there are up to 23 external signals that may be selected (enabled) for generating an interrupt request on a Change-of-State.

There are six control registers associated with the Change Notification (CN) module. The CNEN1 and CNEN2 registers contain the interrupt enable control bits for each of the CN input pins. Setting any of these bits enables a CN interrupt for the corresponding pins.

Each CN pin also has a weak pull-up/pull-down connected to it. The pull-ups act as a current source that is connected to the pin. The pull-downs act as a current sink to eliminate the need for external resistors when push button or keypad devices are connected.

On any pin, only the pull-up resistor or the pull-down resistor should be enabled, but not both of them. If the push button or the keypad is connected to VDD, enable the pull-down, or if they are connected to VSS, enable the pull-up resistors. The pull-ups are enabled separately using the CNPU1 and CNPU2 registers, which contain the control bits for each of the CN pins.

Setting any of the control bits enables the weak pull-ups for the corresponding pins. The pull-downs are enabled separately, using the CNPD1 and CNPD2 registers, which contain the control bits for each of the CN pins. Setting any of the control bits enables the weak pull-downs for the corresponding pins.

When the internal pull-up is selected, the pin uses VDD as the pull-up source voltage. When the internal pull-down is selected, the pins are pulled down to VSS by an internal resistor. Make sure that there is no external pull-up source/pull-down sink when the internal pull-ups/pull-downs are enabled.

Note: Pull-ups and pull-downs on Change Notification pins should always be disabled whenever the port pin is configured as a digital output.

EXAMPLE 11-1: PORT WRITE/READ EXAMPLE (ASSEMBLY LANGUAGE)

```
MOV    #0xFF00, W0           ; Configure PORTB<15:8> as inputs and PORTB<7:0> as outputs
MOV    W0, TRISB
MOV    #0x00FF, W0           ; Enable PORTB<15:8> digital input buffers
MOV    W0, ANSB
NOP                                ; Delay 1 cycle
BTSS   PORTB, #13            ; Next Instruction
```

EXAMPLE 11-2: PORT WRITE/READ EXAMPLE (C LANGUAGE)

```
TRISB = 0xFF00;           // Configure PORTB<15:8> as inputs and PORTB<7:0> as outputs
ANSB = 0x00FF;           // Enable PORTB<15:8> digital input buffers
NOP();                   // Delay 1 cycle
if(PORTBbits.RB13 == 1) // execute following code if PORTB pin 13 is set.
{
}
}
```

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REGISTER 16-1: CCPxCON: CCPx CONTROL REGISTER (STANDARD CCP MODULES)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	DCxB1	DCxB0	CCPxM3 ⁽¹⁾	CCPxM2 ⁽¹⁾	CCPxM1 ⁽¹⁾	CCPxM0 ⁽¹⁾
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
 -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

- bit 15-6 **Unimplemented:** Read as '0'
- bit 5-4 **DCxB<1:0>:** PWM Duty Cycle Bit 1 and Bit 0 for CCPx Module bits
 Capture and Compare modes:
 Unused.
 PWM mode:
 These bits are the two Least Significant bits (bit 1 and bit 0) of the 10-bit PWM duty cycle. The eight Most Significant bits (DCxB<9:2>) of the duty cycle are found in CCPRxL.
- bit 3-0 **CCPxM<3:0>:** CCPx Module Mode Select bits⁽¹⁾
 1111 = Reserved
 1110 = Reserved
 1101 = Reserved
 1100 = PWM mode
 1011 = Compare mode: Special Event Trigger; resets timer on CCPx match (CCPxIF bit is set)
 1010 = Compare mode: Generates software interrupt on compare match (CCPxIF bit is set, CCPx pin reflects I/O state)
 1001 = Compare mode: Initializes CCPx pin high; on compare match, forces CCPx pin low (CCPxIF bit is set)
 1000 = Compare mode: Initializes CCPx pin low; on compare match, forces CCPx pin high (CCPxIF bit is set)
 0111 = Capture mode: Every 16th rising edge
 0110 = Capture mode: Every 4th rising edge
 0101 = Capture mode: Every rising edge
 0100 = Capture mode: Every falling edge
 0011 = Reserved
 0010 = Compare mode: Toggles output on match (CCPxIF bit is set)
 0001 = Reserved
 0000 = Capture/Compare/PWM is disabled (resets CCPx module)

Note 1: CCPxM<3:0> = 1011 will only reset the timer and not start the A/D conversion on a CCPx match.

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REGISTER 16-3: ECCP1AS: ECCP1 AUTO-SHUTDOWN CONTROL REGISTER⁽¹⁾

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ECCPASE	ECCPAS2	ECCPAS1	ECCPAS0	PSSAC1	PSSAC0	PSSBD1	PSSBD0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'
 -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

- bit 15-8 **Unimplemented:** Read as '0'
- bit 7 **ECCPASE:** ECCP1 Auto-Shutdown Event Status bit
 1 = A shutdown event has occurred; ECCP outputs are in a shutdown state
 0 = ECCP outputs are operating
- bit 6-4 **ECCPAS<2:0>:** ECCP1 Auto-Shutdown Source Select bits
 111 = V_{IL} on $\overline{FLT0}$ pin, or either C1OUT or C2OUT is high
 110 = V_{IL} on $\overline{FLT0}$ pin or C2OUT comparator output is high
 101 = V_{IL} on $\overline{FLT0}$ pin or C1OUT comparator output is high
 100 = V_{IL} on $\overline{FLT0}$ pin
 011 = Either C1OUT or C2OUT is high
 010 = C2OUT comparator output is high
 001 = C1OUT comparator output is high
 000 = Auto-shutdown is disabled
- bit 3-2 **PSSAC<1:0>:** P1A and P1C Pins Shutdown State Control bits
 1x = P1A and P1C pins tri-state
 01 = Drive pins, P1A and P1C, to '1'
 00 = Drive pins, P1A and P1C, to '0'
- bit 1-0 **PSSBD<1:0>:** P1B and P1D Pins Shutdown State Control bits
 1x = P1B and P1D pins tri-state
 01 = Drive pins, P1B and P1D, to '1'
 00 = Drive pins, P1B and P1D, to '0'

Note 1: This register is implemented only on PIC24FXXKL40X/30X devices.

- Note 1:** The auto-shutdown condition is a level-based signal, not an edge-based signal. As long as the level is present, the auto-shutdown will persist.
- 2:** Writing to the ECCPASE bit is disabled while an auto-shutdown condition persists.
- 3:** Once the auto-shutdown condition has been removed and the PWM restarted (either through firmware or auto-restart), the PWM signal will always restart at the beginning of the next PWM period.

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REGISTER 19-3: AD1CON3: A/D CONTROL REGISTER 3

R/W-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADRC	EXTSAM	PUMPEN	SAMC4	SAMC3	SAMC2	SAMC1	SAMC0
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	ADCS5	ADCS4	ADCS3	ADCS2	ADCS1	ADCS0
bit 7							bit 0

Legend:

R = Readable bit
-n = Value at POR

W = Writable bit
'1' = Bit is set

U = Unimplemented bit, read as '0'
'0' = Bit is cleared
x = Bit is unknown

bit 15 **ADRC:** A/D Conversion Clock Source bit
 1 = A/D internal RC clock
 0 = Clock derived from system clock

bit 14 **EXTSAM:** Extended Sampling Time bit
 1 = A/D is still sampling after SAMP = 0
 0 = A/D is finished sampling

bit 13 **PUMPEN:** Charge Pump Enable bit
 1 = Charge pump for switches is enabled
 0 = Charge pump for switches is disabled

bit 12-8 **SAMC<4:0>:** Auto-Sample Time bits
 11111 = 31 TAD
 •
 •
 •
 00001 = 1 TAD
 00000 = 0 TAD (not recommended)

bit 7-6 **Unimplemented:** Maintain as '0'

bit 5-0 **ADCS<5:0>:** A/D Conversion Clock Select bits
 11111 = 64 • Tcy
 11110 = 63 • Tcy
 •
 •
 •
 00001 = 2 • Tcy
 00000 = Tcy

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REGISTER 23-3: FOSCSEL: OSCILLATOR SELECTION CONFIGURATION REGISTER

R/P-1	R/P-1	R/P-1	U-0	U-0	R/P-0	R/P-0	R/P-1
IESO	LPRCSEL	SOSCSRC	—	—	FNOSC2	FNOSC1	FNOSC0
bit 7							bit 0

Legend:

R = Readable bit	P = Programmable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared
		x = Bit is unknown

- bit 7 **IESO:** Internal External Switchover bit
 1 = Internal External Switchover mode is enabled (Two-Speed Start-up is enabled)
 0 = Internal External Switchover mode is disabled (Two-Speed Start-up is disabled)
- bit 6 **LPRCSEL:** Internal LPRC Oscillator Power Select bit
 1 = High-Power/High-Accuracy mode
 0 = Low-Power/Low-Accuracy mode
- bit 5 **SOSCSRC:** Secondary Oscillator Clock Source Configuration bit
 1 = SOSC analog crystal function is available on the SOSCI/SOSCO pins
 0 = SOSC crystal is disabled; digital SCLKI function is selected on the SOSCO pin
- bit 4-3 **Unimplemented:** Read as '0'
- bit 2-0 **FNOSC<2:0>:** Oscillator Selection bits
 111 = 8 MHz FRC Oscillator with Divide-by-N (FRCDIV)
 110 = 500 kHz Low-Power FRC Oscillator with Divide-by-N (LPFRCDIV)
 101 = Low-Power RC Oscillator (LPRC)
 100 = Secondary Oscillator (SOSC)
 011 = Primary Oscillator with PLL module (HS+PLL, EC+PLL)
 010 = Primary Oscillator (XT, HS, EC)
 001 = 8 MHz FRC Oscillator with Divide-by-N with PLL module (FRCDIV+PLL)
 000 = 8 MHz FRC Oscillator (FRC)

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24.6 MPLAB X SIM Software Simulator

The MPLAB X SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB X SIM Software Simulator fully supports symbolic debugging using the MPLAB XC Compilers, and the MPASM and MPLAB Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

24.7 MPLAB REAL ICE In-Circuit Emulator System

The MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs all 8, 16 and 32-bit MCU, and DSC devices with the easy-to-use, powerful graphical user interface of the MPLAB X IDE.

The emulator is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with in-circuit debugger systems (RJ-11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

The emulator is field upgradable through future firmware downloads in MPLAB X IDE. MPLAB REAL ICE offers significant advantages over competitive emulators including full-speed emulation, run-time variable watches, trace analysis, complex breakpoints, logic probes, a ruggedized probe interface and long (up to three meters) interconnection cables.

24.8 MPLAB ICD 3 In-Circuit Debugger System

The MPLAB ICD 3 In-Circuit Debugger System is Microchip's most cost-effective, high-speed hardware debugger/programmer for Microchip Flash DSC and MCU devices. It debugs and programs PIC Flash microcontrollers and dsPIC DSCs with the powerful, yet easy-to-use graphical user interface of the MPLAB IDE.

The MPLAB ICD 3 In-Circuit Debugger probe is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with a connector compatible with the MPLAB ICD 2 or MPLAB REAL ICE systems (RJ-11). MPLAB ICD 3 supports all MPLAB ICD 2 headers.

24.9 PICkit 3 In-Circuit Debugger/Programmer

The MPLAB PICkit 3 allows debugging and programming of PIC and dsPIC Flash microcontrollers at a most affordable price point using the powerful graphical user interface of the MPLAB IDE. The MPLAB PICkit 3 is connected to the design engineer's PC using a full-speed USB interface and can be connected to the target via a Microchip debug (RJ-11) connector (compatible with MPLAB ICD 3 and MPLAB REAL ICE). The connector uses two device I/O pins and the Reset line to implement in-circuit debugging and In-Circuit Serial Programming™ (ICSP™).

24.10 MPLAB PM3 Device Programmer

The MPLAB PM3 Device Programmer is a universal, CE compliant device programmer with programmable voltage verification at VDDMIN and VDDMAX for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages, and a modular, detachable socket assembly to support various package types. The ICSP cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 Device Programmer can read, verify and program PIC devices without a PC connection. It can also set code protection in this mode. The MPLAB PM3 connects to the host PC via an RS-232 or USB cable. The MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices, and incorporates an MMC card for file storage and data applications.

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TABLE 26-13: DC CHARACTERISTICS: DATA EEPROM MEMORY

DC CHARACTERISTICS			Standard Operating Conditions: 1.8V to 3.6V Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	Sym	Characteristic	Min	Typ ⁽¹⁾	Max	Units	Conditions
Data EEPROM Memory							
D140	EPD	Cell Endurance	100,000	—	—	E/W	V _{MIN} = Minimum operating voltage Provided no other specifications are violated
D141	VPRD	V _{DD} for Read	V _{MIN}	—	3.6	V	
D143A	TiWD	Self-Timed Write Cycle Time	—	4	—	ms	
D143B	TREF	Number of Total Write/Erase Cycles Before Refresh	—	10M	—	E/W	
D144	TRETDD	Characteristic Retention	40	—	—	Year	
D145	IDDPD	Supply Current during Programming	—	7	—	mA	

Note 1: Data in “Typ” column is at 3.3V, +25°C unless otherwise stated.

TABLE 26-14: DC CHARACTERISTICS: COMPARATOR

Standard Operating Conditions: 2.0V < V _{DD} < 3.6V Operating temperature -40°C < TA ≤ +85°C (unless otherwise stated) -40°C ≤ TA ≤ +125°C for Extended							
Param No.	Symbol	Characteristic	Min	Typ	Max	Units	Comments
D300	VI _{OFF}	Input Offset Voltage	—	20	40	mV	
D301	VI _{CM}	Input Common-Mode Voltage	0	—	V _{DD}	V	
D302	CMRR	Common-Mode Rejection Ratio	55	—	—	dB	

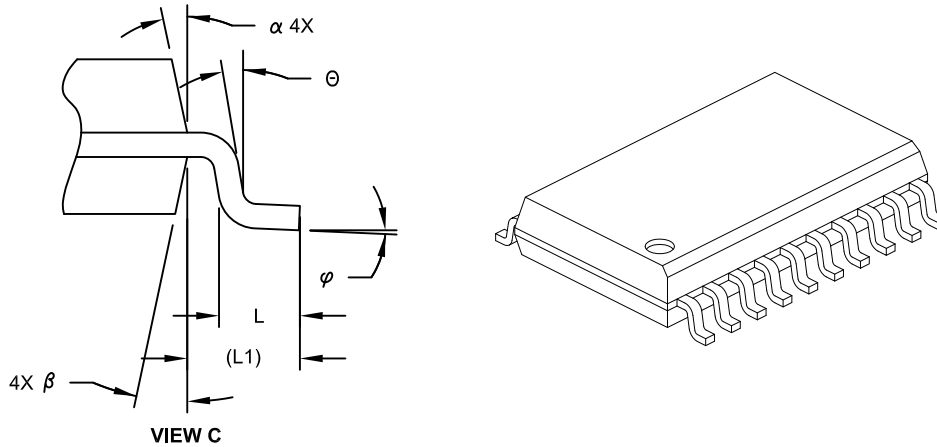
TABLE 26-15: DC CHARACTERISTICS: COMPARATOR VOLTAGE REFERENCE

Standard Operating Conditions: 2.0V < V _{DD} < 3.6V Operating temperature -40°C < TA ≤ +85°C (unless otherwise stated) -40°C ≤ TA ≤ +125°C for Extended							
Param No.	Symbol	Characteristic	Min	Typ	Max	Units	Comments
VRD310	CVRES	Resolution	—	—	V _{DD} /32	LSb	
VRD311	CVRAA	Absolute Accuracy	—	—	A _{VDD} - 1.5	LSb	
VRD312	CVRUR	Unit Resistor Value (R)	—	2k	—	Ω	

PIC24F16KL402 FAMILY

20-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Number of Pins	N	20		
Pitch	e	1.27 BSC		
Overall Height	A	-	-	2.65
Molded Package Thickness	A2	2.05	-	-
Standoff §	A1	0.10	-	0.30
Overall Width	E	10.30 BSC		
Molded Package Width	E1	7.50 BSC		
Overall Length	D	12.80 BSC		
Chamfer (Optional)	h	0.25	-	0.75
Foot Length	L	0.40	-	1.27
Footprint	L1	1.40 REF		
Lead Angle	Θ	0°	-	-
Foot Angle	φ	0°	-	8°
Lead Thickness	c	0.20	-	0.33
Lead Width	b	0.31	-	0.51
Mold Draft Angle Top	α	5°	-	15°
Mold Draft Angle Bottom	β	5°	-	15°

Notes:

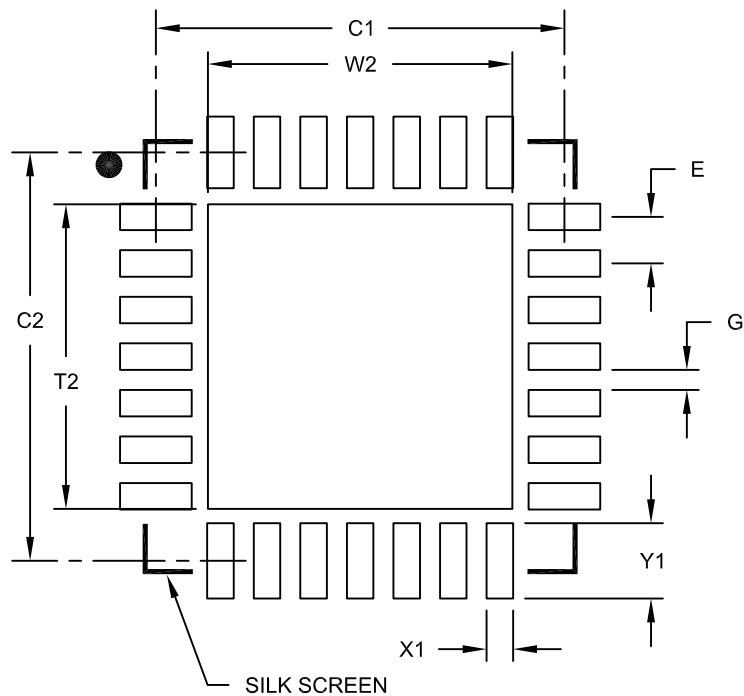
- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic
- Dimension D does not include mold flash, protrusions or gate burrs, which shall not exceed 0.15 mm per end. Dimension E1 does not include interlead flash or protrusion, which shall not exceed 0.25 mm per side.
- Dimensioning and tolerancing per ASME Y14.5M
 BSC: Basic Dimension. Theoretically exact value shown without tolerances.
 REF: Reference Dimension, usually without tolerance, for information purposes only.
- Datums A & B to be determined at Datum H.

Microchip Technology Drawing No. C04-094C Sheet 2 of 2

PIC24F16KL402 FAMILY

28-Lead Plastic Quad Flat, No Lead Package (ML) – 6x6 mm Body [QFN] with 0.55 mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packageing>



RECOMMENDED LAND PATTERN

Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Contact Pitch	E	0.65 BSC		
Optional Center Pad Width	W2			4.25
Optional Center Pad Length	T2			4.25
Contact Pad Spacing	C1		5.70	
Contact Pad Spacing	C2		5.70	
Contact Pad Width (X28)	X1			0.37
Contact Pad Length (X28)	Y1			1.00
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2105A

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